



DFLS240LQ

# 2.0A LOW VF SCHOTTKY BARRIER RECTIFIER PowerDI123

### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F MAX</sub> (V) @ +25°C	I <sub>R MAX</sub> (mA) @ +25°C
40	2.0	0.50	0.1

# Description and Applications

This Schottky Barrier Rectifier has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as:

- Polarity Protection Diode
- · Re-Circulating Diode
- Switching Diode

### **Features and Benefits**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208@3
- Weight: 0.01 grams (Approximate)



Top View

#### **Ordering Information** (Note 5)

Part Number	Compliance	Case	Packaging
DFLS240LQ-7	Automotive	PowerDI123	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



F06A = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2014	20	015	2016	2017	20	18	2019	2020	20	21	2022
Code	В		С	D	Е		=	G	Н		I	J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>R</sub> M V <sub>R</sub> WM V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Forward Current	I <sub>F(AV)</sub>	2.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50	А
Electrostatic Discharge	HBM	4000	V
Electrostatic Discharge	MM	400	V
Electrostatic Discharge	CDM	1	kV

### **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Power Dissipation (Note 6)	P <sub>D</sub>	_	1.67	W
Power Dissipation (Note 7)	P <sub>D</sub>	_	556	mW
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	60	_	°C/W
Thermal Resistance Junction to Ambient (Note 7)	$R_{\theta JA}$	180	_	°C/W
Thermal Resistance Junction to Ambient (Note 8)	$R_{\theta JA}$	135	_	°C/W
Thermal Resistance Junction to Lead (Cathode) (Note 9)	$R_{ heta JL}$	_	6	°C/W
Operating Temperature Range	TJ	-55 to	+125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to	+150	°C

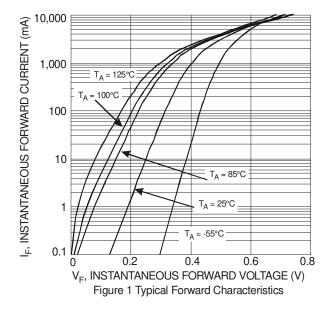
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

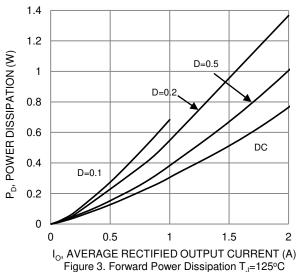
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 10)	$V_{(BR)R}$	40	_	_	<b>V</b>	$I_R = 500\mu A, T_A = +25^{\circ}C$
Forward Voltage	V <sub>F</sub>		0.4 0.45 0.50	0.45 0.50 0.65	٧	I <sub>F</sub> = 1.0A, T <sub>A</sub> = +25°C I <sub>F</sub> = 2.0A, T <sub>A</sub> = +25°C I <sub>F</sub> = 3.0A, T <sub>A</sub> = +25°C
Leakage Current (Note 10)	I <sub>R</sub>			0.1 10 0.05 5	mA	$V_R = 40V, T_A = +25^{\circ}C$ $V_R = 40V, T_A = +85^{\circ}C$ $V_R = 20V, T_A = +25^{\circ}C$ $V_R = 20V, T_A = +85^{\circ}C$
Total Capacitance	$C_T$		90	_	pF	V <sub>R</sub> = 10V, f = 1.0MHz
Switching Speed t <sub>RR</sub>	t <sub>RR</sub>	_	12	_	ns	I <sub>F</sub> =0.5A, I <sub>R</sub> =1A, I <sub>RR</sub> =0.25A (RG1)

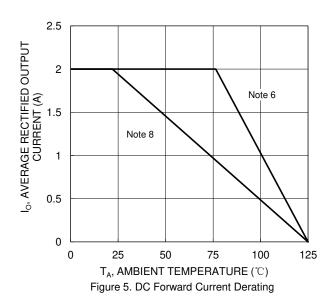
Notes:

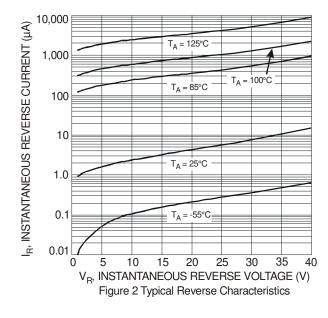
- $6.\ Part\ mounted\ on\ 50.8mm\ X\ 50.8mm\ GETEK\ board\ with\ 25.4mm\ X\ 25.4mm\ copper\ pad,\ 25\%\ anode,\ 75\%\ cathode.$
- 7. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads.
- 8. Part mounted on FR-4 PC board, 2oz.minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- 9. Theoretical R<sub>OJL</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 10. Short duration pulse test used to minimize self-heating effect.

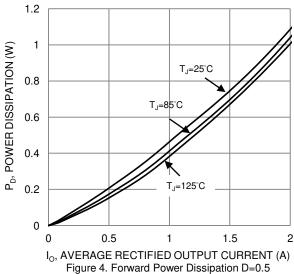












C<sub>T</sub>, JUNCTION CAPACITANCE (pF) f=1MHz V<sub>R</sub>, REVERSE VOLTAGE (V) Figure 6. Typical Junction Capacitance



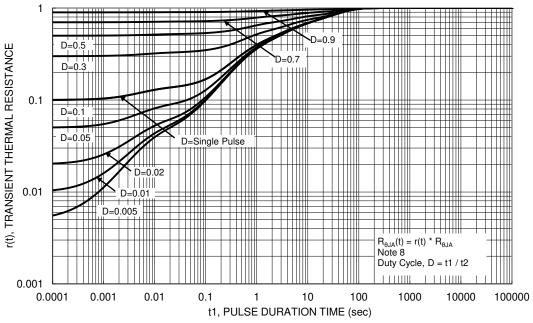


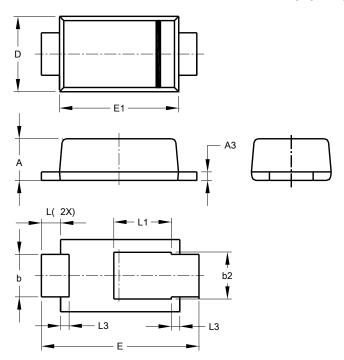
Figure 7. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123

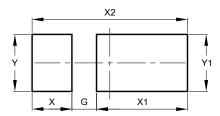


PowerDI123						
Dim	n Min Max Typ					
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123



Dimensions	Value		
Dilliciisions	(in mm)		
G	0.65		
X	1.05		
X1	2.40		
X2	4.10		
Y	1.50		
Y1	1.50		



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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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